## Heraeus

## **Technical Data Sheet**



# THICK FILM MATERIALS

**Product Type:** Conductors

**Product Name:** C8729



## **Plateable Silver Conductor**

#### Description

C8729 is a Pb, Cd and Ni free plateable silver conductor that yields a smooth, dense film. It exhibits high adhesion on alumina substrates. C8729 can be multiple fired without any loss of performance. C8729 is an excellent choice for electrolytic plating applications, such as copper, nickel, tin, etc.

## Key Benefits

- Excellent fired film density
- Low resistivity
- High adhesion
- High speed printing
- Feed through hole application
- Pb, Cd and Ni free

## **Recommended Processing Guidelines**

## **Printing**

280 mesh stainless steel screen 0.5 mil emulsion

## **Printing Speed**

Up to 7 in/sec

## Coverage

 $80 \text{ cm}^2\text{/g}$  at  $12 \mu m$  fired film thickness

## Drying

Allow to level at room temperature for  $5-10\,$  minutes

150 °C for 10 minutes

#### Firing

850 °C peak temperature Dwell time of 10 – 12 minutes Total cycle time 36 – 60 minutes

#### Film Thickness:

## Thinner:

RV-372

## Warranty:

Material guaranteed to meet specifications for 6 months from date of shipment.

## Storage:

Store in a dry location at 5-25 °C.

## DO NOT REFRIGERATE.

Allow paste to come to room temperature prior to opening. Spatulate well before using, as settling may occur during storage.



## **Technical Data Sheet**



## **Plateable Silver Conductor**

## Typical Properties

## Resistivity

< 2.5 m $\Omega/\Box$  at 12 µm fired film thickness

## Adhesion (after plating)

2 x 2 mm pad

Initial:  $\geq 10.0 \text{ lbs}$ Aged:  $\geq 8.0 \text{ lbs}$ 

(500 hours @ 150 °C

500 thermal cycles

 $(-55 \, ^{\circ}\text{C to} + 125 \, ^{\circ}\text{C})$ :  $\geq 10.0 \, \text{lbs}$ 

## Al Wire Bondability

1.25 mil

Initial: > 20.0 g 500 hours @ 150 °C: > 10.0 g \*Note: failure mode: wire breaks Initial: > 600.0 g

Initial: > 600.0 g 500 hours @ 150 °C: > 550.0 g

## Solderability

Sn62/Pb36/Ag2 at 230 °C 10 second dips, RMA flux

 $\begin{array}{ccc} & & \underline{\text{\#of Dips}} & \underline{\text{\% Line Loss}} \\ & & 1 & 10\ \% \\ \text{After plating} & 6 & 5\ \% \\ \end{array}$ 

## Coverage

80 cm $^2$ /g at 12  $\mu$ m fired film thickness

## Viscosity

60 – 100 Kcps Brookfield HBT SC4 – 14 spindle, 6R utility cup at 10 rpm, 25 °C

## Solids

81.5 ± 1.0 %

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<sup>\*</sup>Note: failure mode: wire breaks